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Jameco Part Number 1259444



# SW/SC001/003 Series DC-DC Converter Power Modules: 18-36V & 36-75Vdc Input; 3.3V-15Vdc Output; 1-3.5A Output Current

# **RoHS Compliant**



#### **Applications**

- Wireless Networks
- Distributed power architectures
- Optical and Access Network Equipment
- Enterprise Networks
- Latest generation IC's (DSP, FPGA, ASIC) and Microprocessor powered applications

#### **Options**

- Remote On/Off logic (positive or negative), pin optional for TH version (Suffix 1 or 4)
- Output voltage adjustment-Trim, pin optional for TH version (Suffix 9)
- Surface Mount/Tape and Reel (-SR Suffix)

#### **Features**

- Compliant to RoHS EU Directive 2002/95/EC (-Z versions)
- Compliant to ROHS EU Directive 2002/95/EC with lead solder exemption (non-Z versions)
- Delivers up to 3.5A Output current
   15V (1A), 12V (1.25A), 5.0V (3A) and 3.3V (3.5A)
- High efficiency 86% at 5.0V full load (V<sub>IN</sub>=54 Vdc)
- Low output ripple and noise
  - Small Size and low profile 27.94mm x 24.38mm x 8.5mm (1.10 x 0.96 x 0.335 in)
- Industry Standard pin-out:

  TH version is LW series compatible
- Surface mount (SMT) or Through hole (TH)
- Remote On/Off (optional pin on TH version)
- Output overcurrent/voltage protection
- Single Tightly regulated output
- Output voltage adjustment trim ±10%
- Wide operating temperature range (-40°C to 85°C)
- Meets the voltage insulation requirements for ETSI 300-132-2 and complies with and is Licensed for Basic Insulation rating per EN 60950
- CE mark meets the 2006/95/EC directive§
- UL\* 60950-1Recognized, CSA<sup>†</sup> C22.2 No. 60950-1-03 Certified, and VDE<sup>‡</sup> 0805: (IEC60950, 3<sup>rd</sup> Edition) Licensed
- ISO\*\* 9001 and ISO 14001 certified manufacturing facilities
- Approved for Basic Insulation (-B suffix)

# **Description**

The SW/SC series power modules are isolated dc-dc converters that operate over a wide range of input voltage ( $V_{IN} = 18 - 36 \text{Vdc}$  for SC modules and  $V_{IN} = 36 - 75 \text{Vdc}$  for SW modules) and provide a single precisely regulated output. This series is a low cost, smaller size alternative to the existing LW/LAW/LC with enhanced performance parameters. The output is fully isolated from the input, allowing versatile polarity configurations and grounding connections. The modules exhibit high efficiency, typical efficiency of 86% for 5.0V/3A. Built-in filtering for both input and output minimizes the need for external filtering.

<sup>§</sup> This product is intended for integration into end-use equipment. All of the required procedures of end-use equipment should be followed

<sup>\*</sup> UL is a registered trademark of Underwriters Laboratories, Inc.

<sup>†</sup> CSA is a registered trademark of Canadian Standards Association.

VDE is a trademark of Verband Deutscher Elektrotechniker e.V.
 ISO is a registered trademark of the International Organization of Standards

# **Absolute Maximum Ratings**

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect the device reliability.

| Parameter  | Device | Symbol                 | Min  | Max  | Unit |
|--|--------|------------------------|------|------|------|
| Input Voltage (Continuous)                         | SW     | V <sub>IN</sub>        | -0.3 | 80   | Vdc  |
|  | SC     | $V_{IN}$               | -0.3 | 50   |      |
| Transient (100ms)                                  | All    | $V_{\text{IN, trans}}$ | -0.3 | 100  | Vdc  |
| Operating Ambient Temperature                      | All    | T <sub>A</sub>         | -40  | 85   | °C   |
| (see Thermal Considerations section)               |        |                        |      |      |      |
| Storage Temperature                                | All    | T <sub>stg</sub>       | -55  | 125  | °C   |
| I/O Isolation Voltage (100% factory Hi-Pot tested) | All    | _                      | _    | 2250 | Vdc  |

# **Electrical Specifications**

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

| Parameter   | Device | Symbol                         | Min | Тур | Max  | Unit             |
|---|--------|--------------------------------|-----|-----|------|------------------|
| Operating Input Voltage   | SW     | V <sub>IN</sub>                | 36  | 54  | 75   | Vdc              |
|   | SC     | $V_{IN}$                       | 18  | 27  | 36   | Vdc              |
| Maximum Input Current (V <sub>IN</sub> =0V to 75V, I <sub>O</sub> =I <sub>O, max</sub> )  | SW     | I <sub>IN,max</sub>            |     |     | 0.6  | Adc              |
| $(V_{IN}=0V \text{ to } 36V, I_O=I_{O, max})$   | SC     | I <sub>IN,max</sub>            |     |     | 1.2  | Adc              |
| Inrush Transient  | All    | l <sup>2</sup> t               |     |     | 0.05 | A <sup>2</sup> s |
| Input Reflected Ripple Current, peak-to-peak (5Hz to 20MHz, 12µH source impedance; V <sub>IN</sub> =0V to 75V, I₀= I₀max; see Test configuration section) | All    |                                |     | 30  |      | mAp-p            |
| Input Ripple Rejection (120Hz)  | All    |                                |     | 50  |      | dB               |
| EMC, EN55022  |        | See EMC Considerations section |     |     | •    |                  |

#### CAUTION: This power module is not internally fused. An input line fuse must always be used.

This power module can be used in a wide variety of applications, ranging from simple standalone operation to being part of complex power architecture. To preserve maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a fast-acting fuse with a maximum rating of 3A (see Safety Considerations section). Based on the information provided in this data sheet on inrush energy and maximum dc input current, the same type of fuse with a lower rating can be used. Refer to the fuse manufacturer's data sheet for further information.

# **Electrical Specifications** (continued)

| Parameter  | Device    | Symbol              | Min   | Тур  | Max   | Unit                  |
|--|-----------|---------------------|-------|------|-------|-----------------------|
| Output Voltage Set-point   | All       | V <sub>O, set</sub> | -1.5  | _    | +1.5  | % V <sub>O, set</sub> |
| $(V_{IN}=V_{IN,nom}, I_{O}=I_{O,max}, T_{A}=25^{\circ}C)$  |           |                     |       |      |       |                       |
| Output Voltage   |           | Vo                  | -3.0  | _    | +3.0  | % V <sub>O, set</sub> |
| (Over all operating input voltage, resistive load, and temperature conditions until end of life) |           |                     |       |      |       |                       |
| Adjustment Range   | All       | $V_{O, adj}$        | -10.0 |      | +10.0 | % V <sub>O, set</sub> |
| Selected by external resistor  |           |                     |       |      |       |                       |
| Output Regulation  |           |                     |       |      |       |                       |
| Line ( $V_{IN}=V_{IN, min}$ to $V_{IN, max}$ )   | All       |                     | _     | 0.05 | 0.2   | $\% V_{O, set}$       |
| Load ( $I_0=I_{O, min}$ to $I_{O, max}$ )  | All       |                     | _     | 0.05 | 0.2   | $\% V_{O,  set}$      |
| Temperature ( $T_{ref}$ = $T_{A, min}$ to $T_{A, max}$ )   | All       |                     | _     | _    | 1.00  | % V <sub>O, set</sub> |
| Output Ripple and Noise on nominal output  Measured with 10uF Tantalum and 1uF ceramic           |           |                     |       |      |       |                       |
| $(V_{IN}=V_{IN, nom} I_O=80\%I_{O, max} T_A=25^{\circ}C)$  |           |                     |       |      |       |                       |
| RMS (5Hz to 20MHz bandwidth)   | 5V, 3.3V  |                     | _     | _    | 25    | $mV_{rms}$            |
| Peak-to-Peak (5Hz to 20MHz bandwidth)  | 5V, 3.3V  |                     | _     | _    | 75    | $mV_{pk-pk}$          |
| RMS (5Hz to 20MHz bandwidth)   | 15V, 12V  |                     | _     | _    | 35    | $mV_{rms}$            |
| Peak-to-Peak (5Hz to 20MHz bandwidth)  | 15V, 12V  |                     | _     | _    | 100   | $mV_{pk-pk}$          |
| External Capacitance   | 3.3V, 5V  | C <sub>O, max</sub> | 0     | _    | 1000  | μF                    |
|  | 12V, 15V  | C <sub>O, max</sub> | 0     | _    | 220   | μF                    |
| Output Current   | 15V       | I <sub>o</sub>      | 0     | _    | 1.0   | Adc                   |
|  | 12V       | Io                  | 0     | _    | 1.25  | Adc                   |
|  | 5V        | Io                  | 0     | _    | 3.0   | Adc                   |
|  | 3.3V      | I <sub>o</sub>      | 0     | _    | 3.5   | Adc                   |
| Output Current Limit Inception   | 15V       | $I_{O, lim}$        | 1.1   | _    | _     | Adc                   |
| (Hiccup Mode)  | 12V       | I <sub>O, lim</sub> | 1.4   | _    | _     | Adc                   |
|  | 5V        | I <sub>O, lim</sub> | 3.2   | 4.2  | _     | Adc                   |
|  | 3.3V      | I <sub>O, lim</sub> | 3.7   | _    | _     | Adc                   |
| Output Short-Circuit Current   | 15V       | I <sub>O, s/c</sub> | _     | _    | 0.8   | A rms                 |
| V <sub>O</sub> ≤ 250 mV @ 25° C  | 12V       | I <sub>O, s/c</sub> | _     | _    | 1.2   | A rms                 |
|  | 5V        | I <sub>O, s/c</sub> | _     | _    | 0.7   | A rms                 |
|  | 3.3V      | I <sub>O, s/c</sub> | _     | _    | 1.5   | A rms                 |
| Efficiency   | SW (15V)  | η                   | _     | 88.0 | _     | %                     |
| $V_{IN}$ = $V_{IN, nom}$ , $T_A$ =25°C   | SW (12V)  | η                   | _     | 87.0 | _     | %                     |
| $I_O = I_{O, max}, V_O = V_{O, set}$   | SW (5.0V) | η                   | _     | 86.0 | _     | %                     |
|  | SW (3.3V) | η                   | _     | 85.0 | _     | %                     |
|  | SC (12V)  | η                   | _     | 85.0 | _     |                       |
|  | SC (5.0V) | η                   | _     | 85.5 | _     |                       |
|  | SC (3.3V) | η                   | _     | 85.5 | _     |                       |
| Switching Frequency (Variable with Line & Load)  |           |                     |       |      |       |                       |
| $V_{IN}$ = $V_{IN, nom}$ and $I_O$ = $I_{O, max}$  | All       | f <sub>sw</sub>     | _     | 300  | _     | kHz                   |
| $V_{IN}$ = $V_{IN, nom}$ and $I_O$ = 0.5 x $I_{O, max}$  | All       | f <sub>sw</sub>     | _     | 440  | _     | kHz                   |

# **Electrical Specifications** (continued)

| Parameter   | Device | Symbol         | Min | Тур | Max | Unit             |
|---|--------|----------------|-----|-----|-----|------------------|
| Dynamic Load Response   |        |                |     |     |     |                  |
| $(\Delta Io/\Delta t$ =0.1A/ $\mu$ s, $V_{IN}$ = $V_{IN, nom}$ , $T_A$ =25°C)<br>Load Change from Io= 50% to 75% or 25% to 50% of Io,max: |        |                |     |     |     |                  |
| Peak Deviation  | All    | $V_{pk}$       | _   | 1.5 | _   | $\% V_{O,  set}$ |
| Settling Time (Vo<10% peak deviation)   | All    | t <sub>s</sub> | _   | 800 | _   | μ\$              |

# **Isolation Specifications**

| Parameter             | Symbol           | Min | Тур | Max  | Unit |
|-----------------------|------------------|-----|-----|------|------|
| Isolation Capacitance | C <sub>iso</sub> | _   | 65  | _    | pF   |
| Isolation Resistance  | R <sub>iso</sub> | 10  | _   | _    | МΩ   |
| I/O Isolation Voltage | All              | _   | _   | 2250 | Vdc  |

# **General Specifications**

| Parameter Min Typ Max  |           | Unit       |       |         |
|--|-----------|------------|-------|---------|
| Calculated MTBF (for SW003A0A91 in accordance with Lineage Power RIN: I <sub>O</sub> =80% of I <sub>O, max</sub> , T <sub>A</sub> =25°C, airflow=1m/s) | 8,200,000 |            | Hours |         |
| Weight   | _         | 9.0 (0.32) | _     | g (oz.) |

# **Feature Specifications**

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions. See Feature Descriptions for additional information.

| Parameter  | Device | Symbol                      | Min  | Тур  | Max  | Unit                  |
|--|--------|-----------------------------|------|------|------|-----------------------|
| Remote On/Off Signal Interface   |        |                             |      |      |      |                       |
| $(V_{\text{IN}}\text{=}V_{\text{IN, min}}$ to $V_{\text{IN, max}};$ open collector or equivalent,  |        |                             |      |      |      |                       |
| Signal referenced to V <sub>IN-</sub> terminal)  |        |                             |      |      |      |                       |
| Negative Logic: device code suffix "1"   |        |                             |      |      |      |                       |
| Logic Low = module On, Logic High = module Off   |        |                             |      |      |      |                       |
| Positive Logic: No device code suffix required   |        |                             |      |      |      |                       |
| Logic Low = module Off, Logic High = module On   |        |                             |      |      |      |                       |
| Logic Low - Remote On/Off Current  | All    | I <sub>on/off</sub>         | _    | _    | 1.0  | mA                    |
| Logic Low - On/Off Voltage   | All    | V <sub>on/off</sub>         | -0.7 | _    | 1.2  | V                     |
| Logic High Voltage – (Typ = Open Collector)  | All    | V <sub>on/off</sub>         | _    | 5.8  | 15   | V                     |
| Logic High maximum allowable leakage current   | All    | I <sub>on/off</sub>         | _    | _    | 50   | μΑ                    |
| Turn-On Delay and Rise Times   |        |                             |      |      |      |                       |
| $(I_O=80\% \text{ of } I_{O, max}, T_A=25^{\circ}\text{C})$  |        |                             |      |      |      |                       |
| Case 1: On/Off input is set ON and then input power is applied ( $T_{delay}$ = from instant at which $V_{IN}$ = $V_{IN, min}$ until $V_O$ = 10% of $V_{O, set}$ ).                                   | All    | T <sub>delay</sub><br>Case1 | _    | 20   | 50   | ms                    |
| Case 2: Input power is applied for at least 1 second and then On/Off input is set from OFF to ON ( $T_{delay}$ = from instant at which $V_{IN}$ = $V_{IN, min}$ until $V_O$ = 10% of $V_{O, set}$ ). | All    | T <sub>delay</sub><br>Case2 | _    | 20   | 50   | ms                    |
| T $_{\text{rise}}$ = time for $V_{\text{O}}$ to rise from 10% of $V_{\text{O, set}}$ to 90% of $V_{\text{O, set}}.$  | All    | T <sub>rise</sub>           | _    | 0.1  | 1    | ms                    |
| T $_{\text{rise}}$ = time for $V_{\text{O}}$ to rise from 10% of $V_{\text{O, set}}$ to 90% of $V_{\text{O, set}}$ with max ext capacitance  | All    | T <sub>rise</sub>           | _    | 1.5  | _    | ms                    |
| Output Voltage Overshoot   |        |                             |      |      | 3    | % V <sub>O, set</sub> |
| (I <sub>O</sub> =80% of I <sub>O, max</sub> , V <sub>IN</sub> = 54V, $T_A$ =25°C)  |        |                             |      |      |      |                       |
| Output Overvoltage Protection  | 15V    | $V_{O, limit}$              | 16.6 | _    | 21.0 | V                     |
|  | 12V    | $V_{O, limit}$              | 13.3 | _    | 16.0 | V                     |
|  | 5.0V   | $V_{O, limit}$              | 5.6  | _    | 7.0  | V                     |
|  | 3.3V   | $V_{O, limit}$              | 3.7  | _    | 5.4  | V                     |
| Input Undervoltage Lockout   |        |                             |      |      |      |                       |
| Turn-on Threshold  | SW     | $V_{uv/on}$                 | _    | 33   | 36   | V                     |
| Turn-off Threshold   | SW     | $V_{\text{uv/off}}$         | 27.5 | 30.5 | _    | V                     |
| Hysterisis   | SW     | $V_{hyst}$                  | _    | 2.5  | _    | V                     |
| Turn-on Threshold  | SC     | $V_{uv/on}$                 | _    | 17   | 18   | V                     |
| Turn-off Threshold   | SC     | $V_{\text{uv/off}}$         | 13.5 | 14.5 | _    | V                     |
| Hystersis  | SC     | $V_{hyst}$                  | _    | 3.0  | _    | V                     |

#### **Characteristic Curves**

The following figures provide typical characteristics for the SW001A0C91 (15.0V, 1A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.

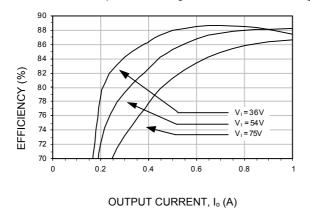
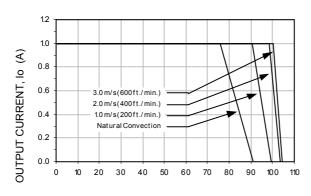
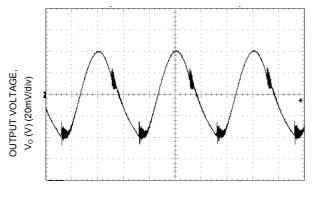


Figure 1. Converter Efficiency versus Output Current.



AMBIENT TEMPERATURE, TA OC

Figure 2. Derating Output Current versus Local Ambient Temperature and Airflow.



TIME, t (1µs/div)

Figure 3. Typical Output Ripple and Noise,  $V_{\text{IN}}\text{=}V_{\text{IN},}$   $_{\text{nom}}$   $I_{\text{O}}\text{=}80\%$  of  $I_{\text{O},\,\text{max}.}$ 

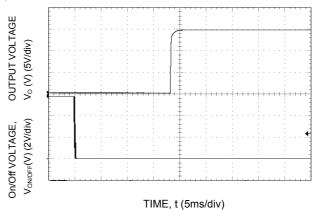


Figure 4. Typical Start-Up Using Remote On/Off, negative logic version shown.

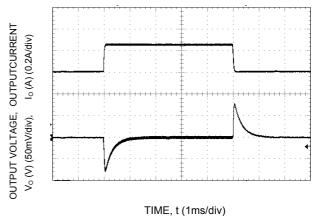
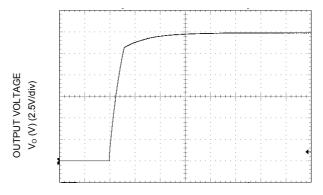


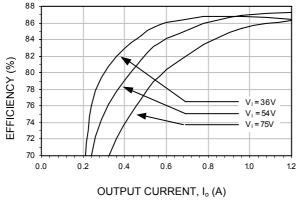
Figure 5. Transient Response to Dynamic Load Change from 50% to 75% to 50% of full load.



TIME, t (500µs/div)

Figure 6. Typical Start-Up Output Voltage Rise Characteristic.

The following figures provide typical characteristics for the SW001A2B91 (12.0V, 1.2A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.



On/Off VOLTAGE, OUTPUT VOLTAGE

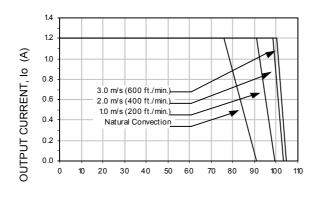
Vowoff(Y) (2V/div)

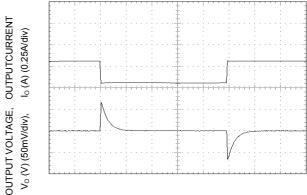
Vo (V) (5V/div)

TIME' t (2ms/qiv)

Figure 7. Converter Efficiency Vs Load at Vo= 12 V.

Figure 10. Typical Start-Up Using Remote On/Off, negative logic version shown.

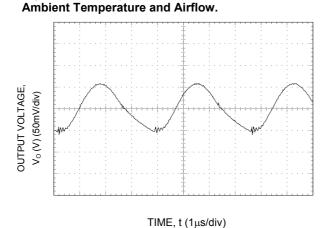




 $\label{eq:ambient} \text{AMBIENT TEMPERATURE, T}_{A} \, ^{o}\text{C}$  Figure 8. Derating Output Current versus Local

Figure 11. Transient Response to Dynamic Load Change from 50% to 75% to 50% of full load.

TIME, t (1.0ms/div)



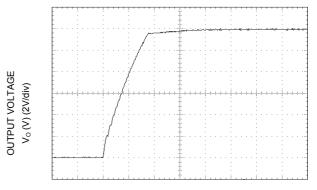


Figure 9. Typical Output Ripple and Noise,  $V_{\text{IN}}\text{=}V_{\text{IN},}$   $_{\text{nom Io}}\text{=}80\%$  of  $I_{\text{O},\,\text{max}.}$ 

Figure 12. Typical Start-Up Output Voltage Rise Characteristic.

TIME, t (100µs/div)

The following figures provide typical characteristics for the SW003A0A91 (5.0V, 3A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.

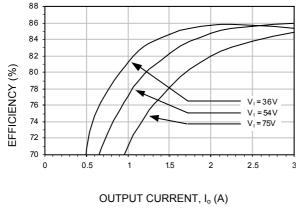


Figure 13. Converter Efficiency Vs Load at Vo= 5V.

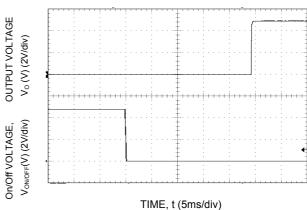
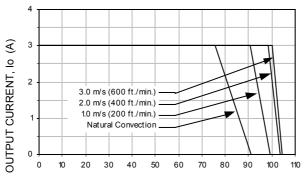


Figure 16. Typical Start-Up Using Remote On/Off, negative logic version shown.



AMBIENT TEMPERATURE,  $T_A$   $^{\mathrm{O}}\mathrm{C}$ 

Figure 14. Derating Output Current versus Local Ambient Temperature and Airflow.

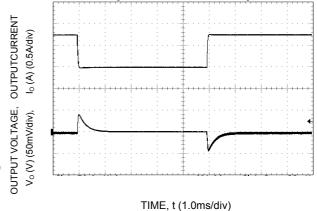


Figure 17. Transient Response to Dynamic Load Change from 50% to 75% to 50% of full load.

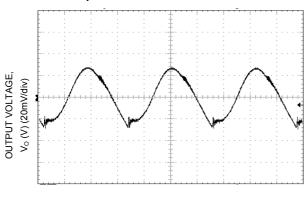
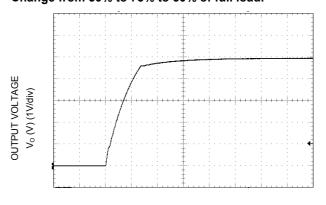


Figure 15. Typical Output Ripple and Noise,  $V_{\text{IN}}\text{=}V_{\text{IN},}$   $_{\text{nom I}_0}\text{=}80\%$  of  $I_{0,\text{ max.}}$ 

TIME, t (1µs/div)



TIME, t (100µs/div)

Figure 18. Typical Start-Up Output Voltage Rise Characteristic.

The following figures provide typical characteristics for the SW003A5F91 (3.3V, 3.5A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.

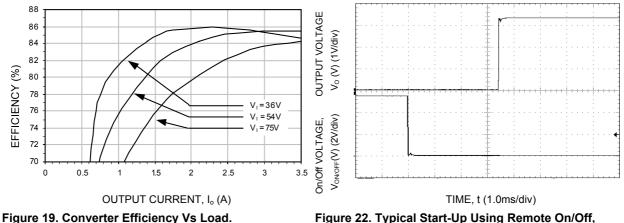


Figure 19. Converter Efficiency Vs Load.

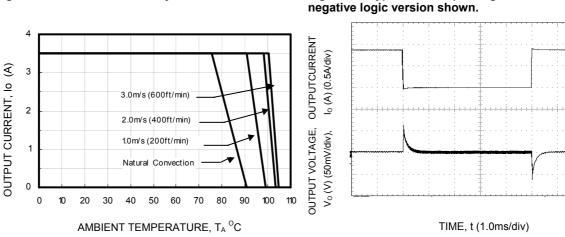


Figure 20. Derating Output Current versus Local Ambient Temperature and Airflow.

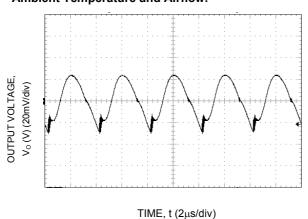


Figure 21. Typical Output Ripple and Noise, VIN=VIN, nom I<sub>O</sub>=80% of I<sub>O, max.</sub>

Figure 23. Transient Response to Dynamic Load Change from 50% to 75% to 50% of full load.

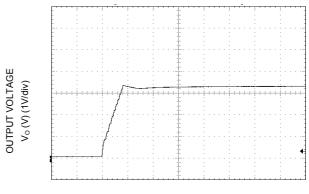


Figure 24. Typical Start-Up Output Voltage Rise Characteristic.

TIME, t (100µs/div)

The following figures provide typical characteristics for the SC001A2B91 (12.0V, 1.2A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.

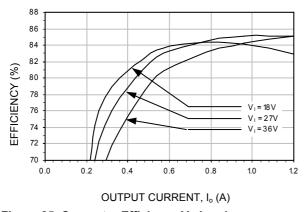


Figure 25. Converter Efficiency Vs Load.

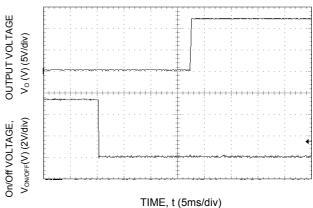
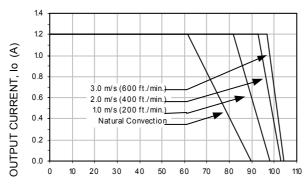
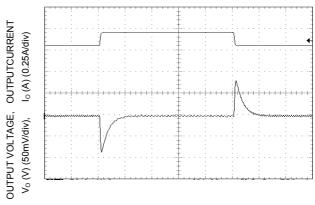


Figure 28. Typical Start-Up Using Remote On/Off, negative logic version shown.



AMBIENT TEMPERATURE, T<sub>A</sub> °C

Figure 26. Derating Output Current versus Local



TIME, t (1.0ms/div)

Figure 29. Transient Response to Dynamic Load

Change from 50% to 75% to 50% of full load.

Ambient Temperature and Airflow.

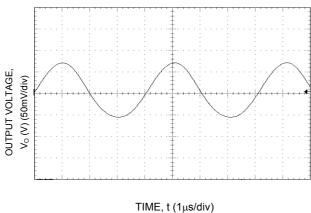
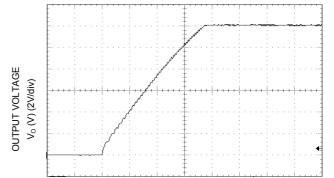


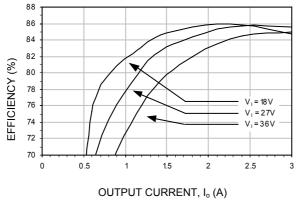
Figure 27. Typical Output Ripple and Noise, V<sub>IN</sub>=V<sub>IN</sub>. nom Io=80% of Io, max.



TIME, t (100µs/div)

Figure 30. Typical Start-Up Output Voltage Rise Characteristic.

The following figures provide typical characteristics for the SC003A0A91 (5.0V, 3A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.



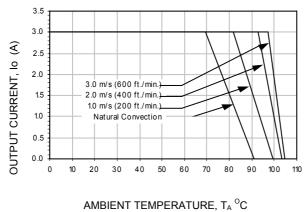
On/Off VOLTAGE, OUTPUT VOLTAGE

VoworF(V) (2V/div) Vo (V) (2V/div)

TIME' f (2W/div)

Figure 31. Converter Efficiency Vs Load.

Figure 34. Typical Start-Up Using Remote On/Off, negative logic version shown.



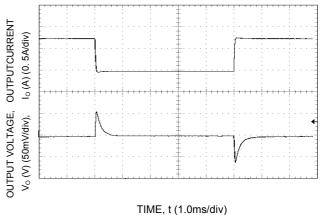
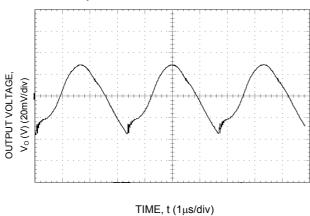
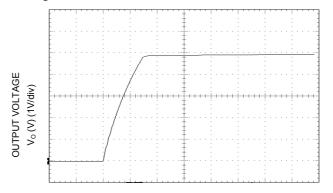


Figure 32. Derating Output Current versus Local Ambient Temperature and Airflow.

Figure 35. Transient Response to Dynamic Load Change from 50% to 75% to 50% of full load.





TIME, t (100µs/div)

Figure 33. Typical Output Ripple and Noise,  $V_{IN}=V_{IN}$ , nom  $I_O=80\%$  of  $I_{O,\ max}$ .

Figure 36. Typical Start-Up Output Voltage Rise Characteristic.

The following figures provide typical characteristics for the SC003A5F91 (3.3V, 3.5A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.

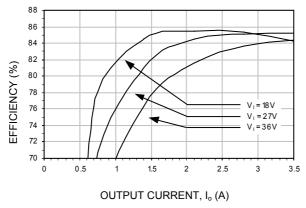


Figure 37. Converter Efficiency Vs Load.

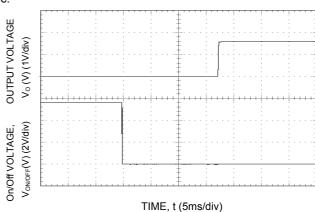
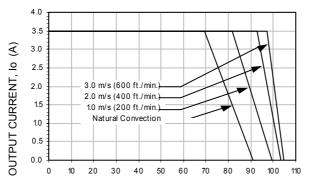


Figure 40. Typical Start-Up Using Remote On/Off, negative logic version shown.



AMBIENT TEMPERATURE, T<sub>A</sub> °C

Figure 38. Derating Output Current versus Local Ambient Temperature and Airflow.

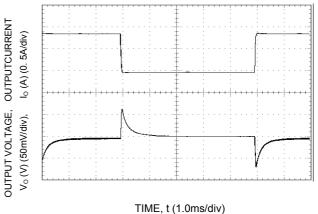


Figure 41. Transient Response to Dynamic Load

Change from 50% to 75% to 50% of full load.

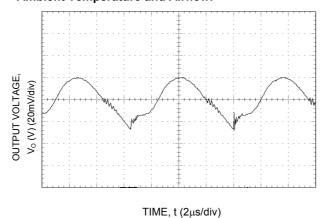


Figure 39. Typical Output Ripple and Noise, V<sub>IN</sub>=V<sub>IN</sub>. nom Io=80% of Io, max.

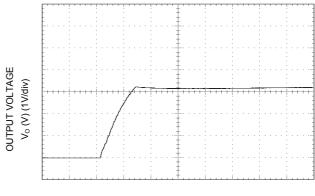
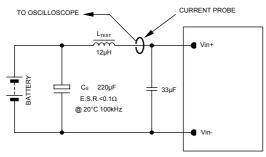


Figure 42. Typical Start-Up Output Voltage Rise Characteristic.

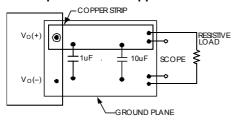
TIME, t (50µs/div)

# **Test Configurations**



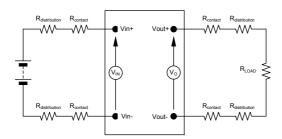
NOTE: Measure input reflected ripple current with a simulated source inductance ( $L_{TST}$ ) of 12µH. Capacitor C<sub>S</sub> offsets possible battery impedance. Measure current as shown above.

Figure 43. Input Reflected Ripple Current Test Setup.



NOTE: All voltage measurements to be taken at the module terminals, as shown above. If sockets are used then Kelvin connections are required at the module terminals to avoid measurement errors due to socket contact resistance.

Figure 44. Output Ripple and Noise Test Setup.



NOTE: All voltage measurements to be taken at the module terminals, as shown above. If sockets are used then Kelvin connections are required at the module terminals to avoid measurement errors due to socket contact resistance.

Figure 45. Output Voltage and Efficiency Test Setup.

Efficiency 
$$\eta = \frac{V_0. I_0}{V_{IN}. I_{IN}} \times 100 \%$$

# **Design Considerations**

#### **Input Source Impedance**

The power module should be connected to a low ac-impedance source. Highly inductive source impedance can affect the stability of the power module. For the test configuration in Figure 43, a  $33\mu F$  electrolytic capacitor (ESR<0.7 $\Omega$  at 100kHz), mounted close to the power module helps ensure the stability of the unit. Consult the factory for further application guidelines.

#### **Safety Considerations**

For safety-agency approval of the system in which the power module is used, the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standard, i.e., UL 60950-1-3, CSA C22.2 No. 60950-00, and VDE 0805 (IEC60950, 3<sup>rd</sup> Edition).

If the input source is non-SELV (ELV or a hazardous voltage greater than 60 Vdc and less than or equal to 75Vdc), for the module's output to be considered as meeting the requirements for safety extra-low voltage (SELV), all of the following must be true:

- The input source is to be provided with reinforced insulation from any other hazardous voltages, including the ac mains.
- One V<sub>IN</sub> pin and one V<sub>OUT</sub> pin are to be grounded, or both the input and output pins are to be kept floating.
- The input pins of the module are not operator accessible.
- Another SELV reliability test is conducted on the whole system (combination of supply source and subject module), as required by the safety agencies, to verify that under a single fault, hazardous voltages do not appear at the module's output.

Note: Do not ground either of the input pins of the module without grounding one of the output pins. This may allow a non-SELV voltage to appear between the output pins and ground.

The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

For input voltages exceeding –60 Vdc but less than or equal to –75 Vdc, these converters have been evaluated to the applicable requirements of BASIC INSULATION between secondary DC MAINS DISTRIBUTION input (classified as TNV-2 in Europe) and unearthed SELV outputs.

The input to these units is to be provided with a maximum 3A time-delay fuse in the ungrounded lead.

#### **Feature Description**

#### Remote On/Off

Two remote on/off options are available. Positive logic turns the module on during a logic high voltage on the ON/OFF pin, and off during a logic low. Negative logic remote On/Off, device code suffix "1", turns the module off during a logic high and on during a logic low.

To maintain compatibility with LW series power modules the Remote On/Off pin is optional for the TH (through hole) version. Standard TH modules have no On/Off pin fitted. TH modules ordered with device code suffix "1" are negative logic with the On/Off pin fitted. The On/Off pin shall always be fitted on SMT versions.

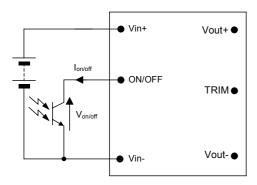


Figure 46. Circuit configuration for using Remote On/Off Implementation.

To turn the power module on and off, the user must supply a switch (open collector or equivalent) to control the voltage ( $V_{on/off}$ ) between the ON/OFF terminal and the  $V_{IN}(-)$  terminal. Logic low is  $0V \le V_{on/off} \le 1.2V$ . The maximum  $I_{on/off}$  during a logic low is 1mA, the switch should be maintain a logic low level whilst sinking this current.

During a logic high, the typical  $V_{\text{on/off}}$  generated by the module is 5.8V, and the maximum allowable leakage current at  $V_{\text{on/off}} = 5.8V$  is  $50\mu A$ .

If not using the remote on/off feature:

For positive logic, leave the ON/OFF pin open.

For negative logic, short the ON/OFF pin to V<sub>IN</sub>(-).

#### **Overcurrent Protection**

To provide protection in a fault (output overload) condition, the unit is equipped with internal current-limiting circuitry and can endure current limiting continuously. At the point of current-limit inception, the unit enters hiccup mode. The unit operates normally once the output current is brought back into its specified range. The average output current during hiccup is 10%  $I_{0, max}$ .

#### **Input Undervoltage Lockout**

At input voltages below the input undervoltage lockout limit, the module operation is disabled. The module will only begin to operate once the input voltage is raised above the undervoltage lockout turn-on threshold,

Once operating, the module will continue to operate until the input voltage is taken below the undervoltage turn-off threshold,  $V_{\text{UV/OFF}}$ .

#### **Over Voltage Protection**

The output overvoltage protection consists of circuitry that internally clamps the output voltage. If a more accurate output overvoltage protection scheme is required then this should be implemented externally via use of the remote on/off pin.

#### **Output Voltage Programming**

Trimming allows the user to increase or decrease the output voltage set point of the module. This is accomplished by connecting an external resistor between the TRIM pin and either the Vout+ pin or the Vout- pin.

Note: Trim pin is optional on TH module version and always present on SMT versions.

#### Trim Down - Decrease Output Voltage

By connecting an external resistor between the TRIM pin and Vout+ pin (Radj-down), the output voltage set point decreases (see figure 17). The following equation determines the external resistor value to obtain an output voltage change from Vo, nom to the desired Vo, adj:

$$R_{adj-down} = \left[\frac{(V_{o,adj} - L) \times G}{(V_{o,nom} - V_{o,adj})} - H\right] \Omega$$

Note: Values for G, H, L and K are defined for each module version in the following table 1.

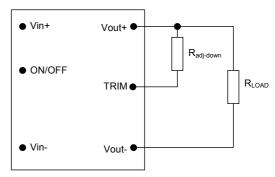


Figure 17. Circuit Configuration to Decrease Output Voltage.

# Feature Descriptions (continued)

#### Trim Up - Increase Output Voltage

By connecting an external resistor between the TRIM pin and Vout- pin (Radj-up), the output voltage set point increases (see figure 48). The following equation determines the external resistor value to obtain an output voltage change from Vo, nom to the desired Vo, adi:

$$R_{adj-up} = \left\lceil \frac{G \times L}{(V_{o, adj} - L - K)} - H \right\rceil \Omega$$

Note: Values for G, H, L and K are defined for each module version in the following table 1.

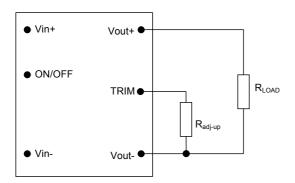


Figure 48. Circuit Configuration to Increase Output Voltage.

**Table 1. Trim Constants SW series** 

| Module   | G      | Н    | K    | L   |
|----------|--------|------|------|-----|
| Sx001A0C | 10,000 | 5110 | 12.5 | 2.5 |
| Sx001A2B | 10,000 | 5110 | 9.5  | 2.5 |
| Sx003A0A | 5110   | 2050 | 2.5  | 2.5 |
| Sx003A5F | 5110   | 2050 | 0.8  | 2.5 |

The combination of the output voltage adjustment and the output voltage initial tolerance must not exceed the allowable trim range of 90% to 110% of the nominal output voltage as measured between the Vout+ and Vout- pins.

The SW/SC power modules have a fixed current-limit set point. Therefore, as the output voltage is adjusted down, the available output power is reduced.

#### **Trim Examples**

For SW003A0A, nominal 5.0V module. To trim module down to 4.90V:

$$R_{adj-down} = \left[ \frac{(4.9 - 2.5) \times 5110}{(5.0 - 4.9)} - 2050 \right] \Omega$$

$$R_{adj-down} = 120,590 \Omega$$

#### **Thermal Considerations**

The power modules operate in a variety of thermal environments; however, sufficient cooling should be provided to help ensure reliable operation.

Considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel.

The thermal reference point, T<sub>ref</sub> used in the specifications is shown in Figure 49. For reliable operation this temperature should not exceed 120°C.

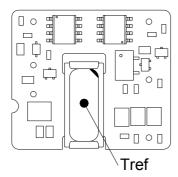


Figure 49. T<sub>ref</sub> Temperature Measurement Location.

#### **Heat Transfer via Convection**

Increased airflow over the module enhances the heat transfer via convection. Derating figures showing the maximum output current that can be delivered by each module versus local ambient temperature ( $T_A$ ) for natural convection and up to 3m/s (600 ft./min) are shown in the respective Characteristics Curves section.

Please refer to the Application Note "Thermal Characterization Process For Open-Frame Board-Mounted Power Modules" for a detailed discussion of thermal aspects including maximum device temperatures.

#### **EMC Considerations**

Figure 50 shows a suggested configuration to meet the conducted emission limits of EN55022 Class B.

Notes: C1, C2, C3 and C6 are low impedance SMT ceramics. C4 is a low impedance polymer film type (Paktron CS4). Common Mode inductor is Pulse Engineering type P0354 1.17mH.

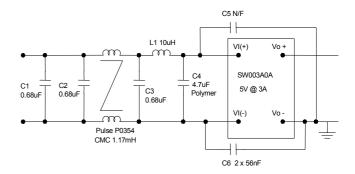


Figure 50. Suggested Configuration for EN55022 Class B.

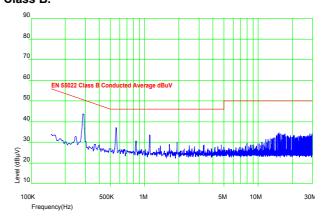


Figure 51. EMC signature using above filter, SW003A0A.

For further information on designing for EMC compliance, please refer to the FLTR100V10 data sheet (FDS01-043EPS).

#### **Layout Considerations**

The SW/SC power module series are low profile in order to be used in fine pitch system card architectures. As such, component clearance between the bottom of the power module and the mounting board is limited. Avoid placing copper areas on the outer layer directly underneath the power module. Also avoid placing via interconnects underneath the power module.

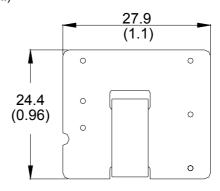
For additional layout guide-lines, refer to the FLTR100V10 data sheet.

#### **Mechanical Outline for SW/SC Surface-Mount Module**

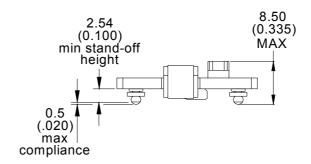
Dimensions are in millimeters and (inches).

Tolerances: x.x mm  $\pm$  0.5 mm (x.xx in.  $\pm$  0.02 in.) [Unless otherwise indicated] x.xx mm  $\pm$  0.25 mm (x.xxx in  $\pm$  0.010 in.)

# **Top View**

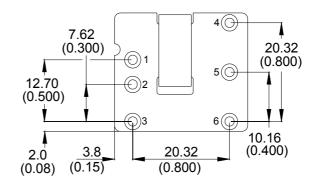


# **Side View**



#### **Bottom View**

| Pi | Function |
|----|----------|
| 1  | Vin +    |
| 2  | Vin -    |
| 3  | ON/OFF   |
| 4  | Vout +   |
| 5  | TRIM     |
| 6  | Vout -   |

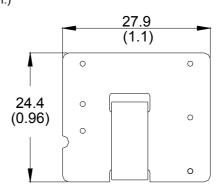


# **Mechanical Outline for SW/SC Through Hole Module**

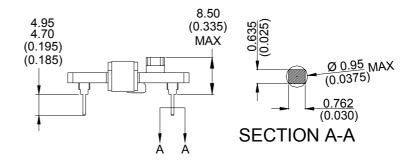
Dimensions are in millimeters and (inches).

Tolerances: x.x mm  $\pm$  0.5 mm (x.xx in.  $\pm$  0.02 in.) [Unless otherwise indicated] x.xx mm  $\pm$  0.25 mm (x.xxx in  $\pm$  0.010 in.)

Top View

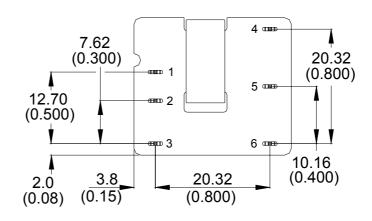


**Side View** 



#### **Bottom View**

| Pi | Function             |
|----|----------------------|
| 1  | Vin +                |
| 2  | Vin -                |
| 3  | ON/OFF<br>(Optional) |
| 4  | Vout +               |
| 5  | TRIM<br>(Optional)   |
| 6  | Vout -               |

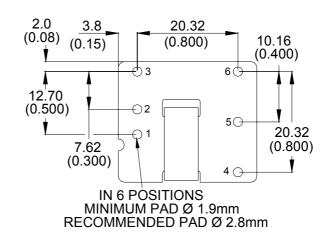


# Recommended Pad Layout for Surface Mount and Through Hole Module

Dimensions are in millimeters and (inches).

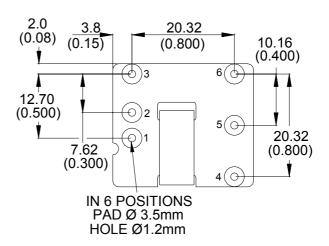
Tolerances: x.x mm  $\pm$  0.5 mm (x.xx in.  $\pm$  0.02 in.) [Unless otherwise indicated] x.xx mm  $\pm$  0.25 mm (x.xxx in  $\pm$  0.010 in.)

| Pin | Function |
|-----|----------|
| 1   | Vin +    |
| 2   | Vin -    |
| 3   | ON/OFF   |
| 4   | Vout +   |
| 5   | TRIM     |
| 6   | Vout -   |



#### Surface Mount Pad Layout - Component side view

| Pin | Function             |
|-----|----------------------|
| 1   | Vin +                |
| 2   | Vin -                |
| 3   | ON/OFF<br>(Optional) |
| 4   | Vout +               |
| 5   | TRIM<br>(Optional)   |
| 6   | Vout -               |



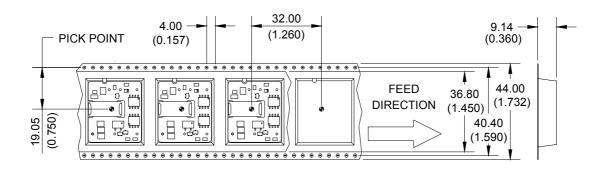
Through-Hole Pad Layout - Component side view

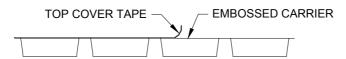
# **Packaging Details**

The SW001/003 series SMT versions are supplied in tape & reel as standard. Details of tape dimensions are shown below. Modules are shipped in quantities of 150 modules per reel.

#### **Tape Dimensions**

Dimensions are in millimeters and (inches).





NOTE: CONFORMS TO EAI-481 REV. A STANDARD

#### **Reel Dimensions**

Outside Diameter: 330.2 mm (13.00")
Inside Diameter: 177.8 mm (7.00")
Tape Width: 44.00 (1.732)

# Through-Hole Lead-Free Soldering Information

The RoHS-compliant through-hole products use the SAC (Sn/Ag/Cu) Pb-free solder and RoHS-compliant components. They are designed to be processed through single or dual wave soldering machines. The pins have an RoHS-compliant finish that is compatible with both Pb and Pb-free wave soldering processes. A maximum preheat rate of 3°C/s is suggested. The wave preheat process should be such that the temperature of the power module board is kept below 210°C. For Pb solder, the recommended pot temperature is 260°C, while the Pb-free solder pot is 270°C max. Not all RoHS-compliant through-hole products can be processed with paste-through-hole Pb or Pb-free reflow process. If additional information is needed, please consult with your Lineage Power representative for more details.

#### **Surface Mount Information**

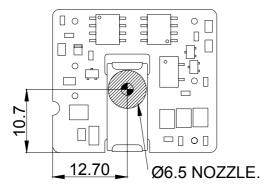
#### **Packaging Details**

The surface mount versions of the SW/SC family (suffix –SR) are supplied as standard in tape and reel. Full details of this packaging will be provided in the full revision of this data sheet.

#### **Pick and Place**

The SW/SC-SR series of DC-to-DC power converters use an open-frame construction and are designed for surface mount assembly within a fully automated manufacturing process.

The SW/SC-SR series modules are designed to use the main magnetic component surface to allow for pick and place.



Note: All dimensions in mm.

Figure 52. Pick and Place Location.

#### **Z Plane Height**

The 'Z' plane height of the pick and place location is 7.50mm nominal with an RSS tolerance of +/-0.25 mm

#### **Nozzle Recommendations**

The module weight has been kept to a minimum by using open frame construction. Even so, they have a relatively large mass when compared with conventional SMT components. Variables such as nozzle size, tip style, vacuum pressure and placement speed should be considered to optimize this process.

The minimum recommended nozzle diameter for reliable operation is 5mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 6.5mm.

Oblong or oval nozzles up to 11 x 6 mm may also be used within the space available.

For further information please contact your local Lineage Power Technical Sales Representative.

#### **Reflow Soldering Information**

The SW/SC family of power modules is available for either Through-Hole (TH) or Surface Mount (SMT) soldering. These power modules are large mass, low thermal resistance devices and typically heat up slower than other SMT components. It is recommended that the customer review data sheets in order to customize the solder reflow profile for each application board assembly.

The following instructions must be observed when SMT soldering these units. Failure to observe these instructions may result in the failure of or cause damage to the modules, and can adversely affect long-term reliability.

The surface mountable modules in the SW/SC family use our SMT technology called "Column Pin" (CP) connectors. Figure 53 shows the CP connector before and after reflow soldering onto the end-board assembly.

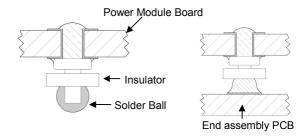


Figure 53. Column Pin Connector Before and After Reflow Soldering.

# Surface Mount Information (continued)

The CP is constructed from a solid copper pin with an integral solder ball attached, which is composed of tin/lead (Sn/Pb) solder. The CP connector design is able to compensate for large amounts of co-planarity and still ensure a reliable SMT solder joint.

Typically, the eutectic solder melts at 183°C, wets the land, and subsequently wicks the device connection. Sufficient time must be allowed to fuse the plating on the connection to ensure a reliable solder joint. There are several types of SMT reflow technologies currently used in the industry. These surface mount power modules can be reliably soldered using natural forced convection, IR (radiant infrared), or a combination of convection/IR. For reliable soldering the solder reflow profile should be established by accurately measuring the modules CP connector temperatures.

#### **Lead Free Soldering**

The –Z version SMT modules of the SW/SC series are lead-free (Pb-free) and RoHS compliant and are compatible in a Pb-free soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability.

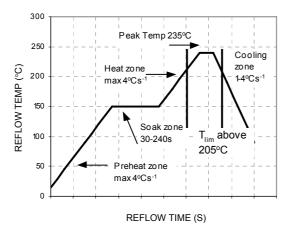


Figure 54. Recommended Reflow Profile.

#### **Pb-free Reflow Profile**

Power Systems will comply with J-STD-020 Rev. C (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. This standard provides a recommended forced-air-convection reflow profile based on the volume and thickness of the package (table 4-2). The

suggested Pb-free solder paste is Sn/Ag/Cu (SAC). The recommended linear reflow profile using Sn/Ag/Cu solder is shown in Figure. 56.

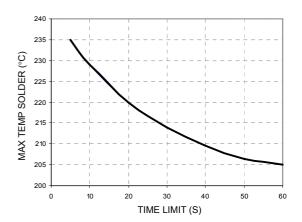


Figure 55. Time Limit Curve Above 205°C Reflow.

#### **MSL Rating**

The SW/SC series SMT modules have a MSL rating of 1

#### **Storage and Handling**

The recommended storage environment and handling procedures for moisture-sensitive surface mount packages is detailed in J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices). Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of  $\leq 30^{\circ}\text{C}$  and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions:  $< 40^{\circ}\text{ C}, < 90\%$  relative humidity.

# Post Solder Cleaning and Drying Considerations

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly. For guidance on appropriate soldering, cleaning and drying procedures, refer to Lineage Power Board Mounted Power Modules: Soldering and Cleaning Application Note (AP01-056EPS).

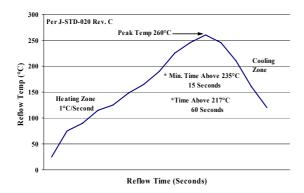


Figure 56. Recommended linear reflow profile using Sn/Ag/Cu solder.

# **Ordering Information**

Please contact your Lineage Power Sales Representative for pricing, availability and optional features.

Table 2. Device Codes

| Product codes    | Input<br>Voltage | Output<br>Voltage | Output<br>Current | Remote On/Off<br>Logic | Connector<br>Type | Comcodes    |
|------------------|------------------|-------------------|-------------------|------------------------|-------------------|-------------|
| SW001A0C91Z      | 48 Vdc           | 15.0V             | 1.0A              | Negative               | Through-Hole      | CC109107331 |
| SW001A2B         | 48 Vdc           | 12.0V             | 1.2A              | Not present            | Through-Hole      | 108989637   |
| SW001A2B9        | 48 Vdc           | 12.0V             | 1.2A              | Not present            | Through-Hole      | 108984576   |
| SW001A2B91       | 48 Vdc           | 12.0V             | 1.2A              | Negative               | Through-Hole      | 108981788   |
| SW001A2B91-33Z   | 48 Vdc           | 12.0V             | 1.2A              | Negative               | Through-Hole      | CC109104568 |
| SW001A2B9Z       | 48 Vdc           | 12.0V             | 1.2A              | Not present            | Through-Hole      | CC109107348 |
| SW001A2B91Z      | 48 Vdc           | 12.0V             | 1.2A              | Negative               | Through-Hole      | CC109107356 |
| SW001A2B94       | 48 Vdc           | 12.0V             | 1.2A              | Positive               | Through-Hole      | 108987314   |
| SW001A2B961-33BZ | 48 Vdc           | 12.0V             | 1.2A              | Negative               | Through-Hole      | CC109120623 |
| SW001A2B91-SR    | 48 Vdc           | 12.0V             | 1.2A              | Negative               | SMT (tape & reel) | 108988787   |
| SW001A2B91-SRZ   | 48 Vdc           | 12.0V             | 1.2A              | Negative               | SMT (tape & reel) | 108995718   |
| SW003A0A         | 48 Vdc           | 5.0V              | 3.0A              | Not present            | Through-Hole      | 108985276   |
| SW003A0A1        | 48 Vdc           | 5.0V              | 3.0A              | Negative               | Through-Hole      | 108985284   |
| SW003A0A9        | 48 Vdc           | 5.0V              | 3.0A              | Not present            | Through-Hole      | 108984790   |
| SW003A0A91       | 48 Vdc           | 5.0V              | 3.0A              | Negative               | Through-Hole      | 108981549   |
| SW003A0A91Z      | 48 Vdc           | 5.0V              | 3.0A              | Negative               | Through-Hole      | CC109107380 |
| SW003A0A94       | 48 Vdc           | 5.0V              | 3.0A              | Positive               | Through-Hole      | 108986928   |
| SW003A0A94Z      | 48 Vdc           | 5.0V              | 3.0A              | Positive               | Through-Hole      | CC109107397 |
| SW003A0A961      | 48 Vdc           | 5.0V              | 3.0A              | Negative               | Through-Hole      | 108989901   |
| SW003A0A9Z       | 48 Vdc           | 5.0V              | 3.0A              | Not present            | Through-Hole      | CC109107372 |
| SW003A0AZ        | 48 Vdc           | 5.0V              | 3.0A              | Not present            | Through-Hole      | CC109107364 |
| SW003A0A91-SR    | 48 Vdc           | 5.0V              | 3.0A              | Negative               | SMT (tape & reel) | 108984550   |
| SW003A0A91-SRZ   | 48 Vdc           | 5.0V              | 3.0A              | Negative               | SMT (tape & reel) | 109100468   |
| SW003A0A94-SRZ   | 48 Vdc           | 5.0V              | 3.0A              | Positive               | SMT (tape & reel) | 109100476   |
| SW003A5F         | 48 Vdc           | 3.3V              | 3.5A              | Not present            | Through-Hole      | 108988275   |
| SW003A5F91       | 48 Vdc           | 3.3V              | 3.5A              | Negative               | Through-Hole      | 108981556   |
| SW003A5F91Z      | 48 Vdc           | 3.3V              | 3.5A              | Negative               | Through-Hole      | CC109107406 |
| SW003A5F94       | 48 Vdc           | 3.3V              | 3.5A              | Positive               | Through-Hole      | 108986902   |
| SW003A5F94Z      | 48 Vdc           | 3.3V              | 3.5A              | Positive               | Through-Hole      | CC109107414 |
| SW003A5F961      | 48 Vdc           | 3.3V              | 3.5A              | Negative               | Through-Hole      | 108989620   |
| SW003A5F91-SR    | 48 Vdc           | 3.3V              | 3.5A              | Negative               | SMT (tape & reel) | 108982059   |
| SW003A5F91-SRZ   | 48 Vdc           | 3.3V              | 3.5A              | Negative               | SMT (tape & reel) | 109100492   |
| SW003A5F94-SR    | 48 Vdc           | 3.3V              | 3.5A              | Positive               | SMT (tape & reel) | 108986910   |
| SW003A5F94-SRZ   | 48 Vdc           | 3.3V              | 3.5A              | Positive               | SMT (tape & reel) | CC109114526 |
|                  |                  |                   |                   |                        | , , ,             |             |
| SC001A2B91       | 24 Vdc           | 12.0V             | 1.2A              | Negative               | Through-Hole      | 108988267   |
| SC001A2B91Z      | 24 Vdc           | 12.0V             | 1.2A              | Negative               | Through-Hole      | CC109107298 |
| SC001A2B91-SR    | 24 Vdc           | 12.0V             | 1.2A              | Negative               | SMT (tape & reel) | 108996468   |
| SC001A2B91-SRZ   | 24 Vdc           | 12.0V             | 1.2A              | Negative               | SMT (tape & reel) | CC109121976 |
| SC003A0A         | 24 Vdc           | 5.0V              | 3.0A              | Not present            | Through-Hole      | 108988291   |
| SC003A0A91       | 24 Vdc           | 5.0V              | 3.0A              | Negative               | Through-Hole      | 108988283   |
| SC003A0A91Z      | 24 Vdc           | 5.0V              | 3.0A              | Negative               | Through-Hole      | CC109107307 |
| SC003A0A94       | 24 Vdc           | 5.0V              | 3.0A              | Positive               | Through-Hole      | 108989967   |
| SC003A0A94Z      | 24 Vdc           | 5.0V              | 3.0A              | Positive               | Through-Hole      | CC109107315 |
| SC003A0A91-SR    | 24 Vdc           | 5.0V              | 3.0A              | Negative               | SMT (tape & reel) | 108988325   |
| SC003A5F         | 24 Vdc           | 3.3V              | 3.5A              | Not present            | Through-Hole      | 108988300   |
| SC003A5F91       | 24 Vdc           | 3.3V              | 3.5A              | Negative               | Through-Hole      | 108982034   |
| SC003A5F91Z      | 24 Vdc           | 3.3V              | 3.5A              | Negative               | Through-Hole      | CC109107323 |
| SC003A5F91-SR    | 24 Vdc           | 3.3V              | 3.5A              | Negative               | SMT (tape & reel) | 108990644   |
| SC003A5F91-SRZ   | 24 Vdc           | 3.3V              | 3.5A              | Negative               | SMT (tape & reel) | 109100435   |

#### **Table 3. Device Options**

| Option*   | Device Code Suffix** |  |
|---|----------------------|--|
| Negative remote on/off logic (On/Off pin fitted) <sup>†</sup> | 1                    |  |
| Positive remote on/off logic (On/Off pin fitted) †            | 4                    |  |
| Short Pins, 3.68 mm ± 0.25mm (0.145 in. ± 0.010 in.)          | 6                    |  |
| Output Voltage Adjustment (Trim pin fitted) †                 | 9                    |  |
| Surface mount connections, SMT (Tape & Reel)                  | -SR                  |  |
| RoHS Compliant  | -Z                   |  |

<sup>\*</sup> Please contact Lineage Power Sales Representative for availability of these options, samples, minimum order quantity and lead times. Legacy device codes may contain a –B option suffix to indicate 100% factory Hi-Pot tested to the isolation voltage specified in the Absolute Maximum Ratings table. The 100% Hi-Pot test is now applied to all device codes, with or without the –B option suffix. Existing comcodes for devices with the –B suffix are still valid; however, no new comcodes for devices containing the –B suffix will be created.

† Either negative or positive logic (1 or 4), and output voltage adjustment (trim, 9) must be ordered on surface mount , SMT (-SR) device codes. Both the on/off pin and trim pin will be provided on all –SR device codes.



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<sup>\*\*</sup> When adding multiple options to the product code, add numerical suffix codes in the descending order.